



**NSAI**  
Standards

Irish Standard Recommendation  
S.R. CLC/TR 62453-51-31:2019

Field device tool (FDT) interface  
specification - Part 51-31: Communication  
implementation for common object model  
- IEC 61784 CP 3/1 and CP 3/2

S.R. CLC/TR 62453-51-31:2019

*Incorporating amendments/corrigenda/National Annexes issued since publication:*

The National Standards Authority of Ireland (NSAI) produces the following categories of formal documents:

I.S. xxx: Irish Standard — national specification based on the consensus of an expert panel and subject to public consultation.

S.R. xxx: Standard Recommendation — recommendation based on the consensus of an expert panel and subject to public consultation.

SWiFT xxx: A rapidly developed recommendatory document based on the consensus of the participants of an NSAI workshop.

*This document replaces/revises/consolidates the NSAI adoption of the document(s) indicated on the CEN/CENELEC cover/Foreword and the following National document(s):*

*NOTE: The date of any NSAI previous adoption may not match the date of its original CEN/CENELEC document.*

*This document is based on:*

CLC/TR 62453-51-31:2019

*Published:*

2019-02-22

*This document was published under the authority of the NSAI and comes into effect on:*

2019-03-12

ICS number:

NOTE: If blank see CEN/CENELEC cover page

NSAI  
1 Swift Square,  
Northwood, Santry  
Dublin 9

T +353 1 807 3800  
F +353 1 807 3838  
E standards@nsai.ie  
W NSAI.ie

Sales:  
T +353 1 857 6730  
F +353 1 857 6729  
W standards.ie

Údarás um Chaighdeáin Náisiúnta na hÉireann

## National Foreword

S.R. CLC/TR 62453-51-31:2019 is the adopted Irish version of the European Document CLC/TR 62453-51-31:2019, Field device tool (FDT) interface specification - Part 51-31: Communication implementation for common object model - IEC 61784 CP 3/1 and CP 3/2

This document does not purport to include all the necessary provisions of a contract. Users are responsible for its correct application.

For relationships with other publications refer to the NSAI web store.

**Compliance with this document does not of itself confer immunity from legal obligations.**

*In line with international standards practice the decimal point is shown as a comma (,) throughout this document.*

This page is intentionally left blank

TECHNICAL REPORT

**CLC/TR 62453-51-31**

RAPPORT TECHNIQUE

TECHNISCHER BERICHT

February 2019

---

ICS 25.040.40; 35.110

English Version

**Field device tool (FDT) interface specification - Part 51-31:  
Communication implementation for common object model - IEC  
61784 CP 3/1 and CP 3/2  
(IEC/TR 62453-51-31:2017)**

Spécification des interfaces des outils des dispositifs de terrain (FDT) - Partie 51-31: Mise en œuvre d'un profil de communication pour le modèle d'objet commun - CP 3/1 et CP 3/2 de l'IEC 61784  
(IEC/TR 62453-51-31:2017)

Field Device Tool (FDT)-Schnittstellenspezifikation - Teil 51-31: Kommunikationsimplementierung mit dem allgemeinen Objektmodell (COM) - Kommunikationsprofilfamilie (CPF) 3/1 und 3/2 nach IEC 61784  
(IEC/TR 62453-51-31:2017)

This Technical Report was approved by CENELEC on 2019-01-07.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Croatia, Cyprus, the Czech Republic, Denmark, Estonia, Finland, Former Yugoslav Republic of Macedonia, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Portugal, Romania, Serbia, Slovakia, Slovenia, Spain, Sweden, Switzerland, Turkey and the United Kingdom.



European Committee for Electrotechnical Standardization  
Comité Européen de Normalisation Electrotechnique  
Europäisches Komitee für Elektrotechnische Normung

**CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels**

---

**CLC/TR 62453-51-31:2019 (E)**

## **European foreword**

This document (CLC/TR 62453-51-31:2019) consists of the text of the IEC/TR 62453-51-31:2017 prepared by IEC/TC 65 "Industrial-process measurement, control and automation".

### **Endorsement notice**

The text of the International Standard IEC/TR 62453-51-31:2017 was approved by CENELEC as a European Standard without any modification.

## Annex ZA (normative)

### Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 When an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: [www.cenelec.eu](http://www.cenelec.eu).

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61158	Series	Industrial communication networks - Fieldbus specifications	EN 61158	Series
IEC 61784-1	2014	Industrial communication networks - Profiles - Part 1: Fieldbus profiles	EN 61784-1	2014
IEC 62453-1	2016	Field device tool (FDT) interface specification - Part 1: Overview and guidance	EN 62453-1	2017
IEC 62453-2	2016	Field device tool (FDT) interface specification - Part 2: Concepts and detailed description	EN 62453-2	2017
IEC/TR 62453-41	2016	Field device tool (FDT) interface specification - Part 41: Object model integration profile - Common object model	-	-
IEC 62453-303-1	2009	Field device tool (FDT) interface specification - Part 303-1: Communication profile	EN 62453-303-1	2009
+ A1	2016	integration - IEC 61784 CP 3/1 and CP 3/2	+ A1	2018

This page is intentionally left blank





**IEC TR 62453-51-31**

Edition 1.0 2017-06

# **TECHNICAL REPORT**



---

**Field device tool (FDT) interface specification –  
Part 51-31: Communication implementation for common object model –  
IEC 61784 CP 3/1 and CP 3/2**





**THIS PUBLICATION IS COPYRIGHT PROTECTED**

**Copyright © 2017 IEC, Geneva, Switzerland**

All rights reserved. Unless otherwise specified, no part of this publication may be reproduced or utilized in any form or by any means, electronic or mechanical, including photocopying and microfilm, without permission in writing from either IEC or IEC's member National Committee in the country of the requester. If you have any questions about IEC copyright or have an enquiry about obtaining additional rights to this publication, please contact the address below or your local IEC member National Committee for further information.

IEC Central Office  
3, rue de Varembe  
CH-1211 Geneva 20  
Switzerland

Tel.: +41 22 919 02 11  
Fax: +41 22 919 03 00  
[info@iec.ch](mailto:info@iec.ch)  
[www.iec.ch](http://www.iec.ch)

**About the IEC**

The International Electrotechnical Commission (IEC) is the leading global organization that prepares and publishes International Standards for all electrical, electronic and related technologies.

**About IEC publications**

The technical content of IEC publications is kept under constant review by the IEC. Please make sure that you have the latest edition, a corrigenda or an amendment might have been published.

**IEC Catalogue - [webstore.iec.ch/catalogue](http://webstore.iec.ch/catalogue)**

The stand-alone application for consulting the entire bibliographical information on IEC International Standards, Technical Specifications, Technical Reports and other documents. Available for PC, Mac OS, Android Tablets and iPad.

**IEC publications search - [www.iec.ch/searchpub](http://www.iec.ch/searchpub)**

The advanced search enables to find IEC publications by a variety of criteria (reference number, text, technical committee,...). It also gives information on projects, replaced and withdrawn publications.

**IEC Just Published - [webstore.iec.ch/justpublished](http://webstore.iec.ch/justpublished)**

Stay up to date on all new IEC publications. Just Published details all new publications released. Available online and also once a month by email.

**Electropedia - [www.electropedia.org](http://www.electropedia.org)**

The world's leading online dictionary of electronic and electrical terms containing 20 000 terms and definitions in English and French, with equivalent terms in 16 additional languages. Also known as the International Electrotechnical Vocabulary (IEV) online.

**IEC Glossary - [std.iec.ch/glossary](http://std.iec.ch/glossary)**

65 000 electrotechnical terminology entries in English and French extracted from the Terms and Definitions clause of IEC publications issued since 2002. Some entries have been collected from earlier publications of IEC TC 37, 77, 86 and CISPR.

**IEC Customer Service Centre - [webstore.iec.ch/csc](http://webstore.iec.ch/csc)**

If you wish to give us your feedback on this publication or need further assistance, please contact the Customer Service Centre: [csc@iec.ch](mailto:csc@iec.ch).



**IEC TR 62453-51-31**

Edition 1.0 2017-06

# TECHNICAL REPORT



---

**Field device tool (FDT) interface specification –  
Part 51-31: Communication implementation for common object model –  
IEC 61784 CP 3/1 and CP 3/2**

INTERNATIONAL  
ELECTROTECHNICAL  
COMMISSION

---

ICS 25.040.40; 35.110.05; 35.110

ISBN 978-2-8322-4324-4

**Warning! Make sure that you obtained this publication from an authorized distributor.**

## CONTENTS

FOREWORD.....	4
INTRODUCTION.....	6
1 Scope.....	7
2 Normative references .....	7
3 Terms, definitions, symbols, abbreviated terms and conventions .....	7
3.1 Terms and definitions.....	7
3.2 Symbols and abbreviated terms .....	8
3.3 Conventions.....	8
3.3.1 Data type names and references to data types .....	8
3.3.2 Vocabulary for requirements .....	8
4 Bus category .....	8
5 Access to instance and device data .....	8
6 Protocol specific behaviour.....	8
6.1 General.....	8
6.2 Representing modularity .....	9
6.2.1 Monolithic DTMs.....	9
6.2.2 Composite Device DTMs .....	10
6.3 Interfaces and information related to Bus Master Configuration.....	13
6.4 Configuration changes in a device .....	13
6.5 Error behaviour: DTM refuses new BMCP .....	14
7 Protocol specific usage of general data types .....	15
8 Network management data types.....	15
8.1 General.....	15
8.2 PROFIBUS device address .....	15
8.3 Master-bus parameter set .....	15
8.4 Slave bus parameter set .....	15
8.5 Module and channel data .....	15
9 Communication data types.....	17
9.1 General.....	17
9.2 DPV0 communication – FDTProfibusDPV0CommunicationSchema .....	18
9.3 DPV1 communication – FDTProfibusDPV1CommunicationSchema .....	19
10 Channel parameter data types.....	22
11 Device identification .....	23
11.1 Device type identification data types – FDTProfibusIdentSchema .....	23
11.2 Topology scan data types – DTMProfibusDeviceSchema .....	24
11.3 Scan identification data types – FDTProfibusScanIdentSchema .....	25
11.4 Device type identification data types – FDTProfibusDeviceIdentSchema .....	27
11.5 XSLT Transformation .....	29
Annex A (informative) Example documents for a DTM representing a remote I/O .....	40
Bibliography.....	43
Figure 1 – Part 51-31 of the IEC 62453 series .....	6
Figure 2 – Device DTM .....	9
Figure 3 – Gateway DTM .....	10
Figure 4 – Composite Device DTM.....	11

Figure 5 – Modular Gateway DTM.....	12
Figure 6 – Interfaces and information related to bus master configuration.....	13
Figure 7 – Changes by the user to the configuration of a device in the DTM user interface .....	14
Figure 8 – Error case – DTM refuses the new BMCP from the Frame Application.....	14
Table 1 – Protocol specific usage of general data types.....	15

## INTERNATIONAL ELECTROTECHNICAL COMMISSION

---

**FIELD DEVICE TOOL (FDT) INTERFACE SPECIFICATION –****Part 51-31: Communication implementation for common object model –  
IEC 61784 CP 3/1 and CP 3/2**

## FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.
- 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
- 6) All users should ensure that they have the latest edition of this publication.
- 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
- 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

The main task of IEC technical committees is to prepare International Standards. However, a technical committee may propose the publication of a technical report when it has collected data of a different kind from that which is normally published as an International Standard, for example "state of the art".

IEC TR 62453-51-31, which is a technical report, has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process management, control and automation.

This document cancels and replaces IEC TR 62453-503-1 published in 2009. This edition constitutes a technical revision. The main changes consist of updates in accordance with IEC 62453-2 in regard to the description of "Composite Device DTM".

IEC TR 62453-51-31:2017 © IEC 2017 – 5 –

Each part of the IEC 62453-51-xy series is intended to be read in conjunction with its corresponding part in the IEC 62453-3xy series. This document corresponds to IEC 62453-303-1.

The text of this technical report is based on the following documents:

Enquiry draft	Report on voting
65E/440/DTR	65E/514/RVC

Full information on the voting for the approval of this technical report can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

The list of all parts of the IEC 62453 series, under the general title *Field device tool (FDT) interface specification*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

**IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.**

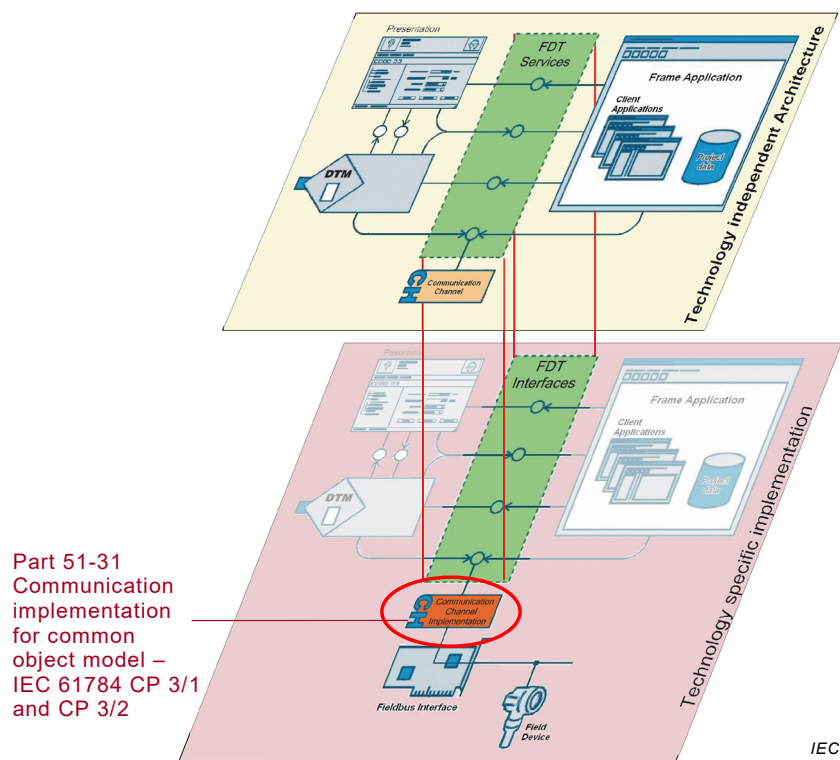
## INTRODUCTION

This part of IEC 62453 is an interface specification for developers of Field Device Tool (FDT) components for function control and data access within a client/server architecture. The specification is a result of an analysis and design process to develop standard interfaces to facilitate the development of servers and clients by multiple vendors that need to interoperate seamlessly.

With the integration of fieldbuses into control systems, there are a few other tasks which need to be performed. In addition to fieldbus- and device-specific tools, there is a need to integrate these tools into higher-level system-wide planning or engineering tools. In particular, for use in extensive and heterogeneous control systems, typically in the area of the process industry, the unambiguous definition of engineering interfaces that are easy to use for all those involved is of great importance.

A device-specific software component, called Device Type Manager (DTM), is supplied by the field device manufacturer with its device. The DTM is integrated into engineering tools via the FDT interfaces defined in this specification. The approach to integration is in general open for all kind of fieldbuses and thus meets the requirements for integrating different kinds of devices into heterogeneous control systems.

Figure 1 shows how this part of IEC 62453-51-xy series is aligned in the structure of the IEC 62453 series.



**Figure 1 – Part 51-31 of the IEC 62453 series**



## FIELD DEVICE TOOL (FDT) INTERFACE SPECIFICATION –

### Part 51-31: Communication implementation for common object model – IEC 61784 CP 3/1 and CP 3/2

#### 1 Scope

This part of the IEC 62435-51-xy series, which is a Technical Report, provides information for integrating the PROFIBUS<sup>1</sup> protocol into the COM-based implementation of FDT interface specification (IEC TR 62453-41).

This part of IEC 62453 specifies implementation of communication and other services based on IEC 62453-303-1.

This document neither contains the FDT specification nor modifies it.

#### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61158 (all parts), *Industrial communication networks – Fieldbus specifications*

IEC 61784-1:2014, *Industrial communication networks – Profiles – Part 1: Fieldbus profiles*

IEC 62453-1:2016, *Field device tool (FDT) interface specification – Part 1: Overview and guidance*

IEC 62453-2:2016, *Field device tool (FDT) interface specification – Part 2: Concepts and detailed description*

IEC TR 62453-41:2016, *Field device tool (FDT) interface specification – Part 41: Object model integration profile – Common object model*

IEC 62453-303-1:2009, *Field device tool (FDT) interface specification – Part 303-1: Communication profile integration – IEC 61784 CP 3/1 and CP 3/2*  
IEC 62453-303-1:2009/AMD1:2016

#### 3 Terms, definitions, symbols, abbreviated terms and conventions

##### 3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 62453-1, IEC 62453-2, IEC TR 62453-41 and IEC 62453-303-1 apply.

---

<sup>1</sup> PROFIBUS™ is a trade name of the non-profit organization PROFIBUS Nutzerorganisation e.V. (PNO). This information is given for the convenience of users of this document and does not constitute an endorsement by IEC of the trade name holder or any of its products. Compliance to this profile does not require use of the registered logos for PROFIBUS™. Use of the registered logos for PROFIBUS™ requires permission of PNO.

This is a free preview. Purchase the entire publication at the link below:

[Product Page](#)

- 
- [Looking for additional Standards? Visit Intertek Inform Infostore](#)
  - [Learn about LexConnect, All Jurisdictions, Standards referenced in Australian legislation](#)
-